### 询"SN74AC245-FP"供应商

- **Controlled Baseline** - One Assembly/Test Site, One Fabrication Site
- **Enhanced Diminishing Manufacturing** Sources (DMS) Support
- **Enhanced Product-Change Notification**
- Qualification Pedigree<sup>†</sup>
- 2-V to 6-V V<sub>CC</sub> Operation
- Inputs Accept Voltages to 6 V
- Max t<sub>pd</sub> of 7 ns at 5 V
- <sup>†</sup> Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

### description/ordering information

The SN74AC245 octal bus transceiver is designed for asynchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

When the output-enable (OE) is low, the device passes noninverted data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction control (DIR) input. A high on OE disables the device so that the buses are effectively isolated.

To ensure the high-impedance state during power up or power down, OE should be tied to V<sub>CC</sub> through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Τ <sub>Α</sub>	PAC	KAGE‡	ORDERABLE PART NUMBER	TOP-SIDE MARKING				
–40°C to 85°C	SOIC – DW	Tape and reel	SN74AC245IDWREP	SAC245IEP				

**ORDERING INFORMATION** 

<sup>‡</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

### **FUNCTION TABLE**

6.60	FUNCT	ION TABLE
INP	UTS	
OE	DIR	OPERATION
L	L	B data to A bus
L	Н	A data to B bus
Н	Х	Isolation



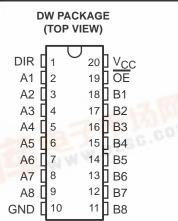
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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include ng of all para

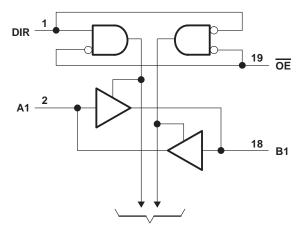


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### SN74AC245-EP OCTAL BUS TRANSCEIVER WITH 3-STATE OUTPUTS SCAS控制自然的原因是00945-EP"供L成了

### logic diagram (positive logic)



**To Seven Other Channels** 

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, V <sub>CC</sub>	–0.5 V to 7 V
Input voltage range, V <sub>I</sub> (see Note 1)	–0.5 V to V <sub>CC</sub> + 0.5 V
Output voltage range, V <sub>O</sub> (see Note 1)	$\dots \dots -0.5$ V to V <sub>CC</sub> + 0.5 V
Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0 or V <sub>I</sub> > V <sub>CC</sub> )	±20 mA
Output clamp current, $I_{OK}$ (V <sub>O</sub> < 0 or V <sub>O</sub> > V <sub>CC</sub> )	±20 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	±50 mA
Continuous current through V <sub>CC</sub> or GND	±200 mA
Package thermal impedance, $\theta_{JA}$ (see Note 2)	58°C/W
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.



### <u>查询"SN74AC245-FP"供应商</u>

### recommended operating conditions (see Note 3)

			MIN	MAX	UNIT
VCC	Supply voltage		2	6	V
		$V_{CC} = 3 V$	2.1		
VIH	High-level input voltage	V <sub>CC</sub> = 4.5 V	3.15		V
		V <sub>CC</sub> = 5.5 V	3.85		
		$V_{CC} = 3 V$		0.9	
VIL	Low-level input voltage	V <sub>CC</sub> = 4.5 V		1.35	V
		V <sub>CC</sub> = 5.5 V		1.65	
VI	Input voltage		0	VCC	V
VO	Output voltage		0	VCC	V
		$V_{CC} = 3 V$		-12	
IOH	High-level output current	$V_{CC} = 4.5 V$		-24	mA
		V <sub>CC</sub> = 5.5 V		-24	
		$V_{CC} = 3 V$		12	
IOL	Low-level output current	$V_{CC} = 4.5 V$		24	mA
		V <sub>CC</sub> = 5.5 V		24	
$\Delta t/\Delta v$	Input transition rise or fall rate			8	ns/V
TA	Operating free-air temperature		-40	85	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



### SN74AC245-EP **OCTAL BUS TRANSCEIVER** WITH 3-STATE OUTPUTS SCAS查询10STOFER209945-FP"供应商

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

			T	A = 25°C	;			
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	UNIT
		3 V	2.9			2.9		
	l <sub>OH</sub> = -50 μA	4.5 V	4.4			4.4		
		5.5 V	5.4			5.4		
VOH	$I_{OH} = -12 \text{ mA}$	3 V	2.56			2.46		V
	1	4.5 V	3.86			3.76		
	I <sub>OH</sub> = -24 mA	5.5 V	4.86			4.76		
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85		
		3 V		0.002	0.1		0.1	
	l <sub>OL</sub> = 50 μA	4.5 V		0.001	0.1		0.1	
		5.5 V		0.001	0.1		0.1	
VOL	I <sub>OL</sub> = 12 mA	3 V			0.36		0.44	V
	1	4.5 V			0.36		0.44	
	I <sub>OL</sub> = 24 mA	5.5 V			0.36		0.44	
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V					1.65	
A or B ports‡	V V an CND				±0.1		±1	Δ
II OE or DIR	V <sub>I</sub> = V <sub>CC</sub> or GND	5.5 V			±0.1		±1	μA
I <sub>OZ</sub>	$V_O = V_{CC} \text{ or GND},  V_I(OE) = V_{IL} \text{ or } V_{IH}$	5.5 V			±0.5		±5	μΑ
ICC	$V_{I} = V_{CC} \text{ or } GND, \qquad I_{O} = 0$	5.5 V			4		40	μΑ
Ci	$V_I = V_{CC}$ or GND	5 V		4.5				pF
C <sub>io</sub>	$V_{O} = V_{CC}$ or GND	5 V		15				pF

<sup>†</sup> Not more than one output should be tested at a time, and the duration of the test should not exceed 2 ms.

<sup>‡</sup> For I/O ports, the parameter I<sub>OZ</sub> includes the input leakage current.

# switching characteristics over recommended operating free-air temperature range, $V_{CC}$ = 3.3 V $\pm\,$ 0.3 V (unless otherwise noted) (see Figure 1)

DADAMETER	FROM	то	Т	<sub>4</sub> = 25°C	;			
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	UNIT
<sup>t</sup> PLH	A er D			5	8.5	1	9	
<sup>t</sup> PHL	A or B	B or A	1.5	5	8.5	1	9	ns
<sup>t</sup> PZH		1 D	2.5	7	11.5	2	12.5	20
<sup>t</sup> PZL	ŌĒ	A or B	2.5	7.5	12	2	13.5	ns
<sup>t</sup> PHZ		A or D	2	6.5	12	1	12.5	20
<sup>t</sup> PLZ	OE	A or B	2	7	11.5	1.5	13	ns



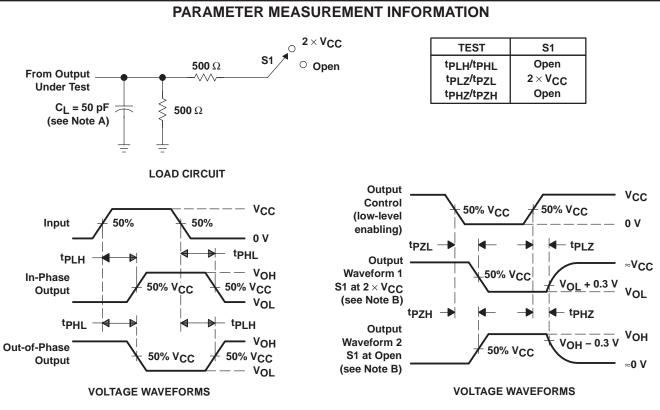
### <u> 查询"SN74AC245-FP"供应商</u>

## switching characteristics over recommended operating free-air temperature range, $V_{CC} = 5 V \pm 5 V$ (unless otherwise noted) (see Figure 1)

	FROM	то	T <sub>A</sub> = 25°C					
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	UNIT
<sup>t</sup> PLH	A as D			3.5	6.5	1	7	
<sup>t</sup> PHL	A or B	B or A	1.5	3.5	6	1	7	ns
<sup>t</sup> PZH	OE	- A D	1.5	5	8.5	1	9	
<sup>t</sup> PZL	ÛE	A or B	1.5	5.5	9	1	9.5	ns
<sup>t</sup> PHZ	OE	A as D	1.5	5.5	9	1	10	
<sup>t</sup> PLZ	ÛE	A or B	1.5	5.5	9	1	10	ns

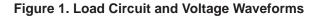
### operating characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

PARAMETER		TEST CO	TYP	UNIT	
C <sub>pd</sub>	Power dissipation capacitance per transceiver	CL = 50 pF,	f = 1 MHz	45	pF



NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
  C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z<sub>O</sub> = 50 Ω, t<sub>f</sub> ≤ 2.5 ns, t<sub>f</sub> ≤ 2.5 ns.
- D. The outputs are measured one at a time, with one input transition per measurement.





18-Sep-2008

### PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins P	ackage Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74AC245IDWREP	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
V62/04760-01XE	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF SN74AC245-EP :

Catalog: SN74AC245

• Military: SN54AC245

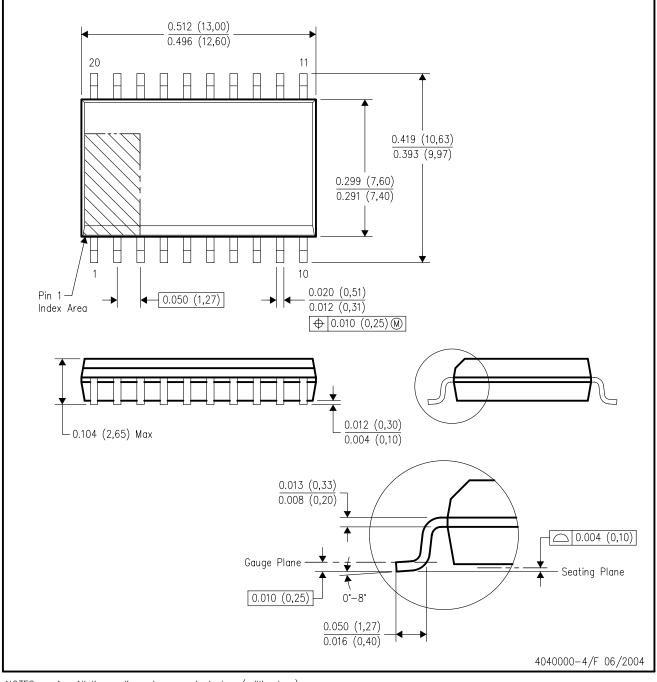
NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

## 查询"SN74AC245-EP"供应商

DW (R-PDSO-G20)

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013 variation AC.



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